

Title (en)

Method and measurement system for producing a reference by a powder press

Title (de)

Verfahren und Meßsystem zur Bildung einer Referenz bei einer Pulverpresse

Title (fr)

Procédé et système de mesure pour produire une référence dans une presse à poudre

Publication

EP 1782943 A3 20090603 (DE)

Application

EP 06021575 A 20061014

Priority

DE 102005052158 A 20051102

Abstract (en)

[origin: EP1782943A2] The method involves manufacturing of reference die (42) or at least a reference stamp. The reference die is mounted on the die plate (14). The position of the top edge of the reference die is measured and the position value is stored with the optical measuring device which is alternatively arranged on base plate (16) or die plate. The reference die is mounted on the die plate. A sum of reference die values and reference stamp values are formed and stored as distance of the adapter plate to die plate. An independent claim is included for formation of reference with powder press.

IPC 8 full level

B30B 11/00 (2006.01)

CPC (source: EP US)

B30B 11/005 (2013.01 - EP US); **B30B 15/0094** (2013.01 - EP US); **B30B 15/028** (2013.01 - EP US)

Citation (search report)

- [Y] EP 1074380 A2 20010207 - KOSMEK KK [JP]
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Designated contracting state (EPC)

AT BE BG CH CY CZ DE DK EE ES FI FR GB GR HU IE IS IT LI LT LU LV MC NL PL PT RO SE SI SK TR

Designated extension state (EPC)

AL BA HR MK RS

DOCDB simple family (publication)

EP 1782943 A2 20070509; EP 1782943 A3 20090603; EP 1782943 B1 20141217; DE 102005052158 A1 20070503;
DE 102005052158 B4 20080103; US 2007096351 A1 20070503; US 7803294 B2 20100928

DOCDB simple family (application)

EP 06021575 A 20061014; DE 102005052158 A 20051102; US 58560106 A 20061024